



| Parameter | Rating | Units |
|---------------------|--------|--------------------------------------|
| Load Voltage | 600 | V _P |
| Load Current | 100 | mA _{rms} / mA _{DC} |
| On-Resistance (max) | 50 | Ω |

Features

- 5000V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 8-Pin Package
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The PAA193 is a dual normally open (1-Form-A) solid state relay that uses optically coupled relay technology to provide an enhanced 5000V_{rms} input to output isolation barrier. The efficient MOSFET switches use IXYS IC Division's patented OptoMOS architecture. Highly efficient GaAIAs infrared LEDs provide the optically coupled control.

Dual OptoMOS relays provide a more compact design solution than discrete single-pole relays in a variety of applications. The dual relays save board space by incorporating two relays in a single 8-pin package.

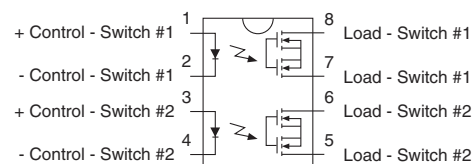
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

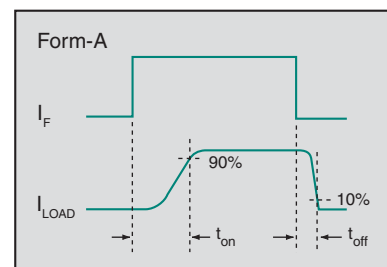
Ordering Information

| Part # | Description |
|-----------|----------------------------------|
| PAA193 | 8-Lead DIP (50/tube) |
| PAA193S | 8-Lead Surface Mount (50/tube) |
| PAA193STR | 8-Lead Surface Mount (1000/Reel) |

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

| Parameter | Ratings | Units |
|--------------------------------------|-------------|------------------|
| Blocking Voltage | 600 | V _p |
| Reverse Input Voltage | 5 | V |
| Input Control Current | 50 | mA |
| Peak (10ms) | 1 | A |
| Input Power Dissipation ¹ | 150 | mW |
| Total Power Dissipation ² | 800 | mW |
| Isolation Voltage, Input to Output | 5000 | V _{rms} |
| Operational Temperature | -40 to +85 | °C |
| Storage Temperature | -40 to +125 | °C |

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

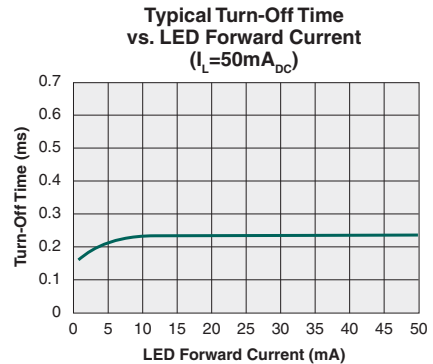
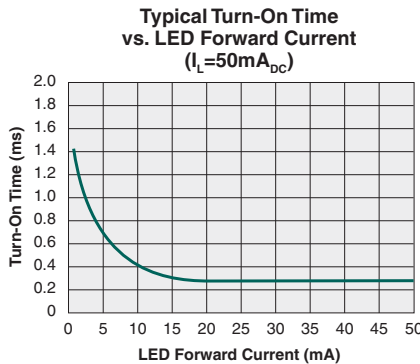
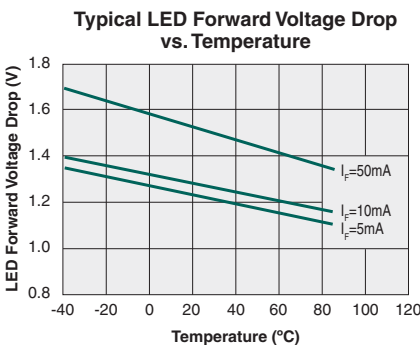
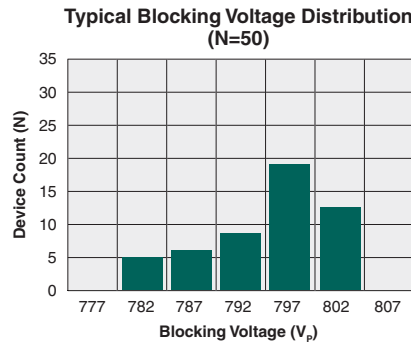
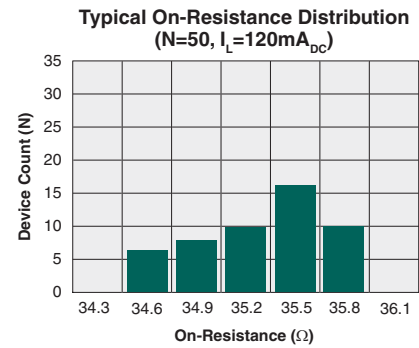
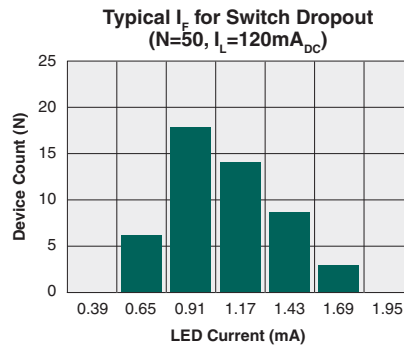
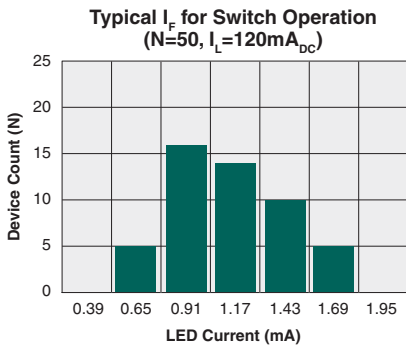
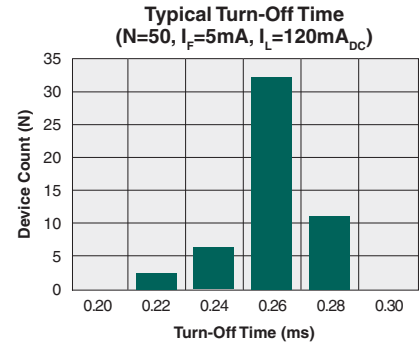
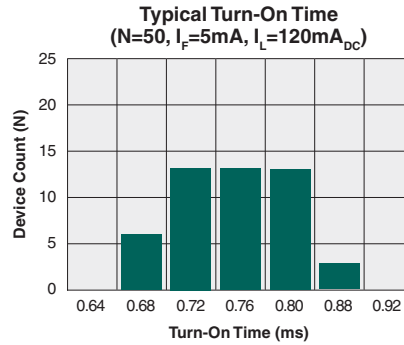
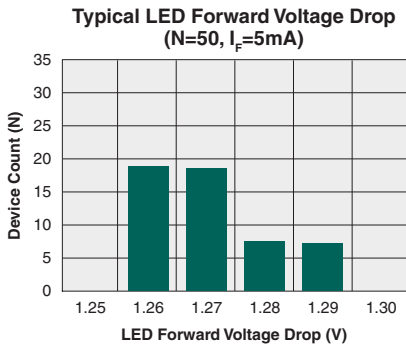
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
|-----------------------------------|--|-------------------|-----|-----|------|--------------------------------------|
| Output Characteristics | | | | | | |
| Load Current | | | | | | |
| Continuous * | - | I _L | - | - | 100 | mA _{rms} / mA _{DC} |
| Peak | t=10ms | I _{LPK} | - | - | ±350 | mA _p |
| On-Resistance | I _L =100mA | R _{ON} | - | - | 50 | Ω |
| Off-State Leakage Current | V _L =600V _p | I _{LEAK} | - | - | 10 | μA |
| Switching Speeds | | | | | | |
| Turn-On | I _F =5mA, V _L =10V | t _{on} | - | - | 5 | ms |
| Turn-Off | | t _{off} | - | - | 5 | |
| Output Capacitance | V _L =50V, f=1MHz | C _{OUT} | - | 50 | - | pF |
| Input Characteristics | | | | | | |
| Input Control Current to Activate | I _L =100mA | I _F | - | - | 5 | mA |
| Input Voltage Drop | I _F =5mA | V _F | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | V _R =5V | I _R | - | - | 10 | μA |
| Common Characteristics | | | | | | |
| Capacitance, Input to Output | - | C _{I/O} | - | 3 | - | pF |

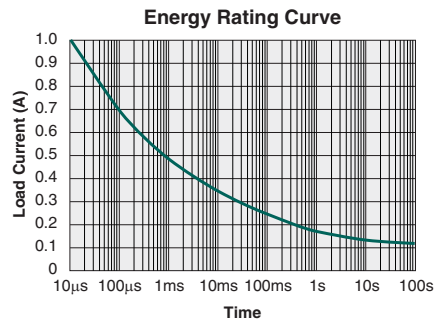
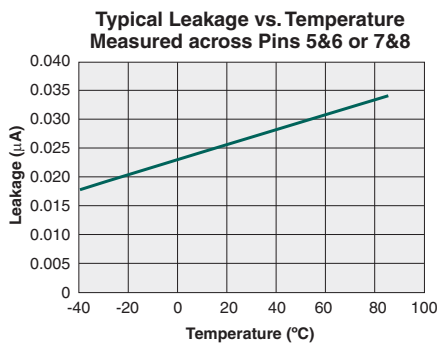
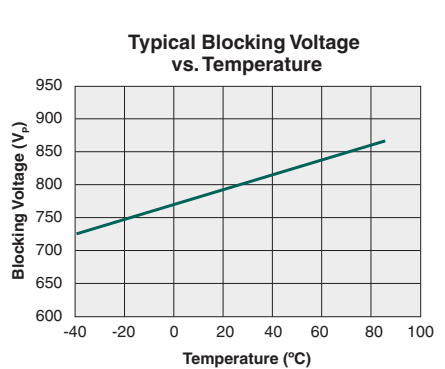
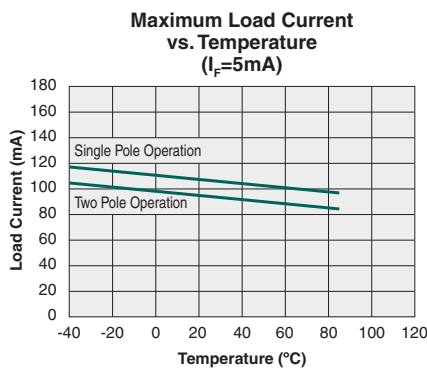
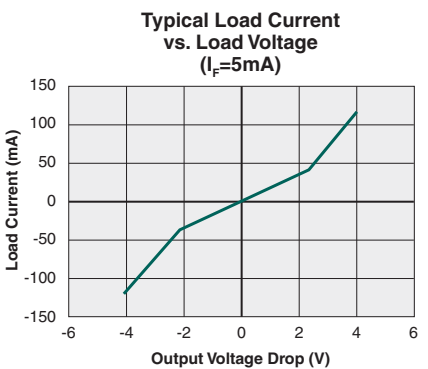
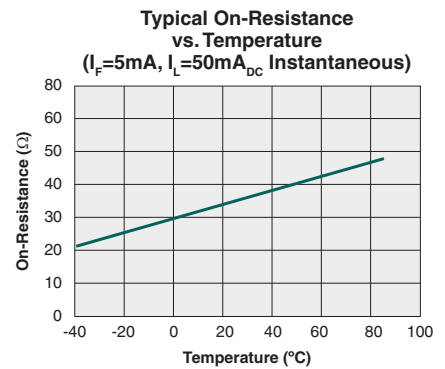
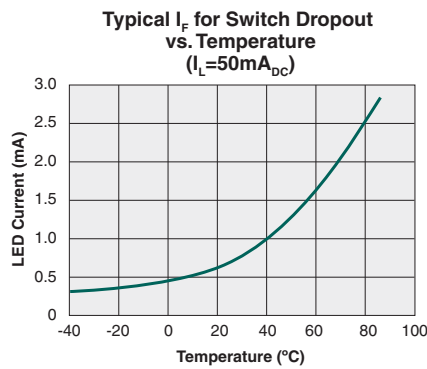
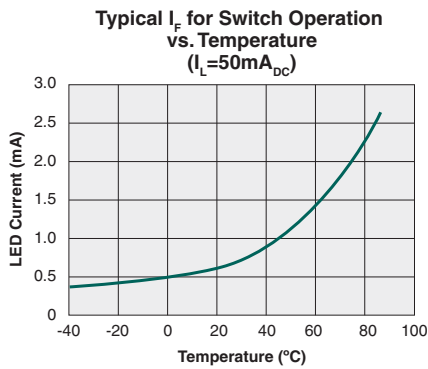
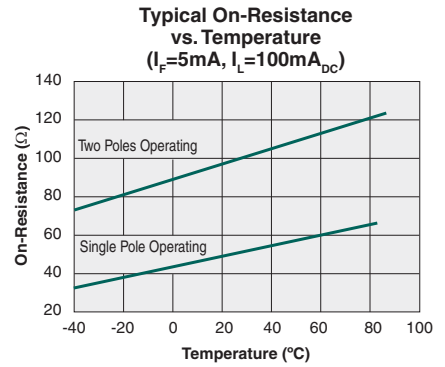
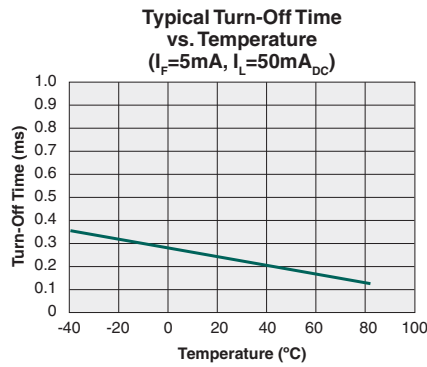
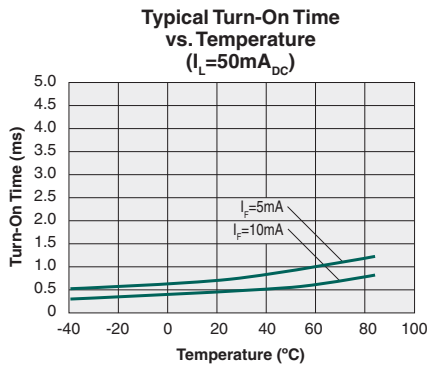
*NOTE: If both poles operate simultaneously, then load current must be derated in order not to exceed the package power dissipation value.

PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Rating |
|------------------|---|
| PAA193 / PAA193S | MSL 1 |

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device | Maximum Temperature x Time |
|------------------|----------------------------|
| PAA193 / PAA193S | 250°C for 30 seconds |

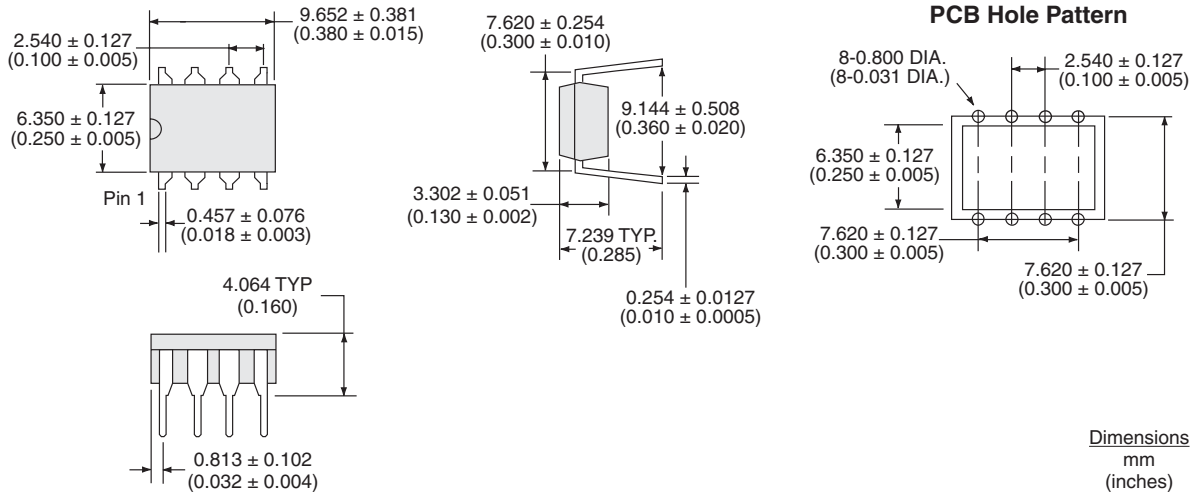
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

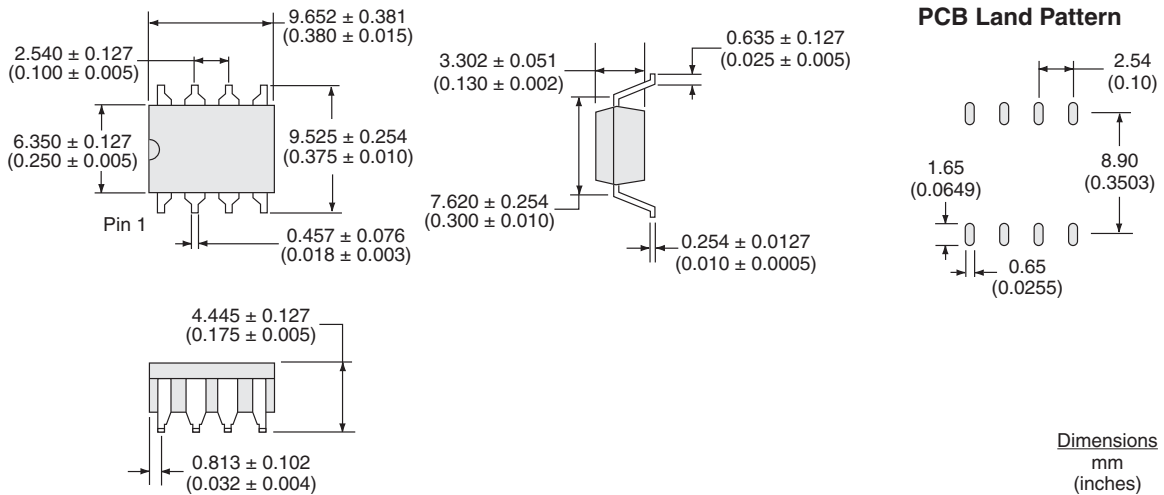


Mechanical Dimensions

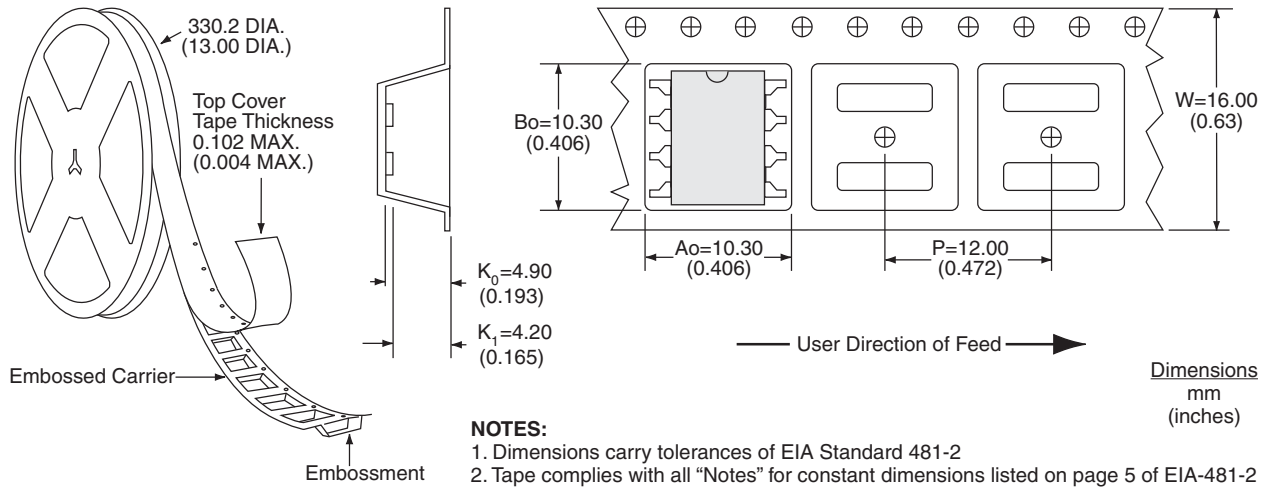
PAA193



PAA193S



PAA193STR Tape & Reel



For additional information please visit our website at: www.ixysic.com

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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